45V 4A QUAD POWER HALF BRIDGE

PRODUCT PREVIEW

1 FEATURES

- MULTIPOWER BCD TECHNOLOGY
- MINIMUM INPUT OUTPUT PULSE WIDTH DISTORTION
- 200mΩ R_{dsON} COMPLEMENTARY DMOS OUTPUT STAGE
- CMOS COMPATIBLE LOGIC INPUTS
- THERMAL PROTECTION
- THERMAL WARNING OUTPUT
- UNDER VOLTAGE PROTECTION
- SHORT CIRCUIT PROTECTION

2 DESCRIPTION

STA506A is a monolithic quad half bridge stage in Multipower BCD Technology.

The device can be used as dual bridge or reconfigured, by connecting CONFIG pin to Vdd pin, as single bridge with double current capability, and as half

Figure 1. Package



Table 1. Order Codes

Part Number	Package
STA506A	Power SO36 (Slug Up)

bridge (Binary mode) with half current capability.

The device is particularly designed to make the output stage of a stereo All-Digital High Efficiency (DDXTM) amplifier capable to deliver 60 + 60W @ THD = 10% at V_{CC} 32V output power on 8 Ω load and 80W @ THD = 10% at V_{CC} 36V on 8 Ω load in single BTL configuration. In single BTL configuration is also capable to deliver a peak of 120W @THD = 10% at V_{CC} = 32V on 4 Ω load. The input pins have threshold proportional to V_L pin voltage.

+V_{cc} C55 1000µF C30 1µF мз IN1A L18 22uH VI 23 +3.3V OUT1A C20 100nF 16 CONFIG OUT1A M2 C52 14 GND1A C99 00nF 330pF PROTECTIONS FAULT R57 R59 10K C23 470nF 8Ω LOGIC 12 V_{CC}1B R100 R63 20 C101 100nF C58 100nF 6 C31 M5 11 C21 TH WAR OUT1B 10 100nF TH_WAR L19 22µH IN1B 30 OUT1B IN1B M4 VDF 13 GND1B 21 VDD 22 REGULATORS 33 V_{SS} 24 M17 C32 1uF C58 100nF C53 100nf L113 22µH SIGN OUT2A C110 100nF C60 100nF ŧ V_{CC}SIGN OUT2A C109 330pF M15 GND2A R103 C107 100nF IN2A IN2A C108 470nF GND-Rea 20 V_{CC}2B R104 20 B102 C106 100nF GND-Clea M16 C33 1uE OUT2B 00nF 2 IN2B IN2E OUT2E _____ L112 22uF M14 5 GND2F D004111148B

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This is preliminary information on a new product now in development. Details are subject to change without notice.

Figure 2. Application Circuit (Dual BTL)

Table 2. Pin Function

Pin n.	Pin Name	Description		
1	GND-SUB	Substrate Ground		
2 ; 3	OUT2B	Dutput Half Bridge 2B		
4	V _{CC} 2B	Positive Supply		
5	GND2B	Negative Supply		
6	GND2A	Negative Supply		
7	V _{CC} 2A	Positive Supply		
8;9	OUT2A	Output Half Bridge 2A		
10 ; 11	OUT1B	Output Half Bridge 1B		
12	V _{CC} 1B	Positive Supply		
13	GND1B	Negative Supply		
14	GND1A	Negative Supply		
15	V _{CC} 1A	Positive Supply		
16 ; 17	OUT1A	Output Half Bridge 1A		
18	NC	Not Connected		
19	GND-clean	Logical Ground		
20	GND-reg	Ground for regulator V _{dd}		
21 ; 22	V _{dd}	5V Regulator Referred to Ground		
23	VL	Logic Reference Voltage		
24	CONFIG	Configuration pin		
25	PWRDN	Stand-by pin		
26	TRI-STATE	High-Z pin		
27	FAULT	Fault pin Advisor		
28	TH-WAR	Thermal Warning Advisor		
29	IN1A	Input of Half Bridge 1A		
30	IN1B	Input of Half Bridge 1B		
31	IN2A	Input of Half Bridge 2A		
32	IN2B	Input of Half Bridge 2B		
33 ; 34	V _{SS}	5V Regulator Referred to +V _{CC}		
35 ; 36	V _{CC} Sign	Signal Positive Supply		

Table 3. Functional Pin Status

Pin name	Pin n.	Logical value	IC -STATUS
FAULT	27	0	Fault detected (Short circuit, or Thermal)
FAULT ^(*)	27	1	Normal Operation
TRI-STATE	26	0	All powers in Hi-Z state
TRI-STATE	26	1	Normal operation
PWRDN	25	0	Low absorpion
PWRDN	25	1	Normal operation
THWAR	28	0	Temperature of the IC =130°C
THWAR ^(*)	28	1	Normal operation
CONFIG	24	0	Normal Operation
CONFIG ^(**)	24	1	OUT1A = OUT1B ; OUT2A=OUT2B (IF IN1A = IN1B; IN2A = IN2B)

The pin is open collector. To have the high logic value, it needs to be pulled up by a resistor.

(*) : (**): To put CONFIG = 1 means connect Pin 24 (CONFIG) to Pins 21, 22 (Vdd) to implement single BTL (mono mode) operation for high current.

Figure 3. Pin Connection





Symbol	Parameter	Value	Unit
V _{CC}	DC Supply Voltage (Pin 4,7,12,15)	45	V
V _{max}	Maximum Voltage on pins 23 to 32 (logic reference)	5.5	V
P _{tot}	Power Dissipation ($T_{case} = 70^{\circ}C$)	50	W
T _{op}	Operating Temperature Range	0 to 70	°C
T _{stg} , T _j	Storage and Junction Temperature	-40 to 150	°C

Table 4. Absolute Maximum Ratings

Table 5. (*) Recommended Operating Conditions

Symbol	Parameter	Min.	Тур.	Max.	Unit
Vcc	DC Supply Voltage	10		40	V
VL	Input Logic Reference	2.7	3.3	5.0	v
T _{amb}	Ambient Temperature	0		70	°C

(*) Performances not guaranteed beyond recommended Operating Conditions

Table 6. Thermal Data

Symbol	Parameter	Min.	Тур.	Max.	Unit
T _{j-case}	Thermal Resistance Junction to Case (thermal pad)			1.5	°C/W
T _{jSD}	Thermal shut-down junction temperature		150		°C
T _{warn}	Thermal warning temperature		130		°C
t _{hSD}	Thermal shut-down hysteresis		25		°C

Table 7. Electrical Characteristcs: refer to circuit in Fig.1 ($V_L = 3.3V$; $V_{CC} = 32V$; $R_L = 8\Omega$; $f_{sw} = 384$ KHz; $T_{amb} = 25^{\circ}$ C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
R _{dsON}	Power Pchannel/Nchannel MOSFET RdsON	Id=1A		200	270	mΩ
I _{dss}	Power Pchannel/Nchannel leakage Idss	V _{CC} =35V			50	μA
ЯN	Power Pchannel RdsON Matching	Id=1A	95			%
ЯР	Power Nchannel RdsON Matching	Id=1A	95			%
Dt_s	Low current Dead Time (static)	see test circuit no.1; see fig. 3		10	20	ns
Dt_d	High current Dead Time (dinamic)	L=22 μ H; C = 470nF; R _L = 8 Ω Id=3.5A; see fig. 5			50	ns
t _{d ON}	Turn-on delay time	Resistive load			100	ns
t _d OFF	Turn-off delay time	Resistive load			100	ns
tr	Rise time	Resistive load; as fig.3			25	ns
t _f	Fall time	Resistive load; as fig. 3			25	ns
V _{CC}	Supply voltage operating voltage		10		40	V
V _{IN-H}	High level input voltage				V _L /2 +300mV	V

Table 7. (continued)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{IN-L}	Low level input voltage		V _L /2 - 300mV			V
I _{IN-H}	Hi level Input current	Pin Voltage = V _L		1		μA
I _{IN-L}	Low level input current	Pin Voltage = 0.3V		1		μA
I _{PWRDN-H}	Hi level PWRDN pin input current	$V_{L} = 3.3V$		35		μA
V _{LOW}	Low logical state voltage VLow (pin PWRDN, TRISTATE) (note 1)	V _L = 3.3V	0.8			V
V _{HIGH}	High logical state voltage VHigh (pin PWRDN, TRISTATE) (note 1)	V _L = 3.3V			1.7	V
I _{VCC} - PWRDN	Supply CURRENT from Vcc in Power Down	PWRDN = 0			3	mA
IFAULT	Output Current pins FAULT -TH-WARN when FAULT CONDITIONS	Vpin = 3.3V		1		mA
I _{VCC-hiz}	Supply Current from Vcc in Tri- state	$V_{CC} = 30V$; Tri-state = 0		22		mA
Ivcc	Supply Current from Vcc in operation both channel switching)	V _{CC} =30V; Input Pulse width = 50% Duty; Switching Frequency = 384KHz; No LC filters;		50		mA
I _{VCC-q}	Isc (short circuit current limit) (note 2)		4	6	8	A
V _{UV}	Undervoltage protection threshold			7		V
t _{pw_min}	Output minimum pulse width	No Load	70		150	ns

Notes: 1. The following table explains the $V_{\text{LOW}},\,V_{\text{HIGH}}$ variation with V_{L}

Table 8.

VL	VLOW min	V _{HIGH} max	Unit
2.7	0.7	1.5	V
3.3	0.8	1.7	V
5	0.85	1.85	V

Note 2: see relevant Application Note AN1994

Table 9. Logic Truth Table (see fig. 4)

TRI-STATE	INxA	INxB	Q1	Q2	Q3	Q4	OUTPUT MODE
0	х	х	OFF	OFF	OFF	OFF	Hi-Z
1	0	0	OFF	OFF	ON	ON	DUMP
1	0	1	OFF	ON	ON	OFF	NEGATIVE
1	1	0	ON	OFF	OFF	ON	POSITIVE
1	1	1	ON	ON	OFF	OFF	Not used



Figure 4. Test Circuit.



Figure 5.



Figure 6.



3 TECHNICAL INFO:

The STA506A is a dual channel H-Bridge that is able to deliver more than 60W per channel (@ THD=10%) of audio output power in high efficiency.

The STA506A converts both DDX and binary-controlled PWM signals into audio power at the load. It includes a logic interface , integrated bridge drivers, high efficiency MOSFET outputs and thermal and short circuit protection circuitry.

In DDX mode, two logic level signals per channel are used to control high-speed MOSFET switches to connect the speaker load to the input supply or to ground in a Bridge configuration, according to the damped ternary Modulation operation.

In Binary Mode operation , both Full Bridge and Half Bridge Modes are supported. The STA506A includes overcurrent and thermal protection as well as an under-voltage

Lockout with automatic recovery if FAULT and TRISTATE pins are connected together to an external capacitor, as in fig.9





Figure 8. STA506A Block Diagram Binary Half-Bridge Mode



3.1 Logic Interface and Decode:

The STA506A power outputs are controlled using one or two logic level timing signals. In order to provide a proper logic interface, the V_L input must operate at the dame voltage as the DDX control logic supply.

3.2 Protection Circuitry:

The STA506A includes protection circuitry for over-current and thermal overload conditions. A thermal warning pin (pin.28) is activated low (open drain MOSFET) when the IC temperature exceeds 130°C, in advance of the thermal shutdown protection. When a fault condition is detected, an internal fault signal acts to immediately disable the output power MOSFETs, placing both H-Bridges in high impedance state. At the same time an open-drain MOSFET connected to the fault pin (pin.27) is switched on.



There are two possible modes subsequent to activating a fault:

 - 1) SHUTDOWN mode: with FAULT (pull-up resistor) and TRI-STATE pins independent, an activated fault will disable the device, signaling low at the FAULT output.

The device may subsequently be reset to normal operation by toggling the TRI-STATE pin from High to Low to High using an external logic signal.

- 2) AUTOMATIC recovery mode: This is shown in the Application Circuit of fig.1.

The FAULT and TRI-STATE pins are shorted together and connected to a time constant circuit comprising R59 and C58.

An activated FAULT will force a reset on the TRI-STATE pin causing normal operation to resume following a delay determined by the time constant of the circuit.

If the fault condition is still present , the circuit operation will continue repeating until the fault condition is removed .

An increase in the time constant of the circuit will produce a longer recovery interval. Care must be taken in the overall system design as not to exceed the protection thesholds under normal operation.

3.3 Power Outputs:

The STA506A power and output pins are duplicated to provide a low impedance path for the device's bridged outputs .

All duplicate power, ground and output pins must be connected for proper operation.

The PWRDN or TRI-STATE pins should be used to set all MOSFETS to the Hi-Z state during power-up until the logic power supply, V_L , is settled.

3.4 Parallel Output / High Current Operation:

When using DDX Mode output , the STA506A outputs can be connected in parallel in order to increase the output current capability to a load.

In this configuration the STA506A can provide 80W into 8 ohm or up to 120W into 4ohm.

This mode of operation is enabled with the CONFIG pin (pin.24) connected to Vdd and the inputs combined IN1A=IN1B, IN2A=IN2B and the outputs combined OUT1A=OUT1B, OUT2A=OUT2B.

3.5 Additional Informations:

Output Filter: A passive 2nd-order passive filter is used on the STA506A power outputs to reconstruct an analog Audio Signal .

System performance can be significantly affected by the output filter design and choice of passive components. A filter design for 6ohm/8ohm loads is shown in the Typical Application circuit of fig.1. Figure 9 shows a filter design suitable for 4ohm loads.

Figure 10 shows a filter for $\frac{1}{2}$ bridge mode , 4 ohm loads.

3.6 Power Dissipation & Heat Sink Requirements:

The power dissipated within the device will depend primarily on the supply voltage, load impedance and output modulation level.

The PowerSO36 package of the STA506A includes an exposed thermal slug on the top of the device to provide a direct thermal path from the IC to the heatsink.

Careful consideration must be given to the overall thermal design . See figure 8 for power derating

versus Slug temperature using different heatsinks and considering the Rth-jc =1.5°C/W.



Figure 9. STA506A Power Derating Curve



Figure 10. Typical Single BTL Configuration to Obtain 120W @ THD 10%, RL= 4Ω, V_{CC} = 32V (note 1))



Note: 1. "A PWM modulator as driver is needed . In particular, this result is performed using the STA30X+STA50X demo board". Peak Power for t ≤1sec







For more information refer to the application notes AN1456 and AN1661

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Figure 12. THD+N vs Frequency



Figure 13. Output Power vs Vsupply



Figure 14. THD+N vs Output Power



Figure 15. THD+N vs Output Power



Table 10. THD+N vs Output Power





Figure 16. Power SO36 (Slug Up) Mechanical Data & Package Dimensions

ым		mm		inch			
DIN.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	3.25		3.43	0.128		0.135	
A2	3.1		3.2	0.122		0.126	
A4	0.8		1	0.031		0.039	
A5		0.2			0.008		
a1	0.030		-0.040	0.0011		-0.0015	
b	0.22		0.38	0.008		0.015	
С	0.23		0.32	0.009		0.012	
D	15.8		16	0.622		0.630	
D1	9.4		9.8	0.37		0.38	
D2		1			0.039		
Е	13.9		14.5	0.547		0.57	
E1	10.9		11.1	0.429		0.437	
E2			2.9			0.114	
E3	5.8		6.2	0.228		0.244	
E4	2.9		3.2	0.114		1.259	
е		0.65			0.026		
e3		11.05			0.435		
G	0		0.075	0		0.003	
Н	15.5		15.9	0.61		0.625	
h			1.1			0.043	
L	0.8		1.1	0.031		0.043	
Ν			10°			10°	
S			8 °			8°	

(1) "D and E1" do not include mold flash or protusions. Mold flash or protusions shall not exceed 0.15mm (0.006") (2) No intrusion allowed inwards the leads.

> ⊕0,12 MAB

A

D1

D

Μ

((

19

B



Ν

(slug tail width)

F4

36

Table 11. Revision History

Date	Revision	Description of Changes
August 2004	1	First Issue
November 2004	2	Changed Vcc from 9 min to 10 min



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